OPE5T87

DIMENSIONS (Unit: mm)

2-_0.5

2.54

① Cathode

② Anode

Tolerance: ±0.2mm

The **OPE5T87** is GaAlAs infrared emitting diode that is designed for high power, low forward voltage and high speed rise / fall time. This device is optimized for speed and efficiency at emission wavelength 880nm and has a high radiant efficiency over a wide range of forward current. This device is packaged T1-3/4 plastic package and has narrow beam angle with lensed package and cup frame. Especially this device is suited as the emitter of data transmission without cable.

FEATURES

- Ultra high-speed: 25ns rise time
- 880nm wavelength
- Narrow beam angle
- Low forward voltage
- High power and high reliability
- Available for pulse operating

APPLICATIONS

- Emitter of IrDA
- IR Audio and Telephone
- High speed IR communication
- IR LANs
- Available for wireless digital data transmission

STORAGE

- Condition: 5°C~35°C,R.H.60%
- Terms : within 3 months from production date
- Remark: Once the package is opened, the products should be used within a day.

 Otherwise, it should be keeping in a damp proof box with desiccants.
- * Please take proper steps in order to secure reliability and safety in required conditions and environments for this device.

MAXIMUM RATINGS

T	`ລ=	=25	200	1
(1	a-	-23	\mathbf{C}	,

Item		Symbol	Rating	Unit
Power Dissipation		P_{D}	150	mW
Forward current		I_{F}	100	mA
Pulse forward current		I_{FP}	1.0	A
Reverse voltage		V_R	4.0	V
Operating temp.		Topr.	- 25∼ +85	°C
Soldering temp. *2		Tsol.	260.	°C

 $^{^{*1}}$. Duty ratio = 1/100, pulse width=0.1ms.

ELECTRO-OPTICALCHARACTERISTICS

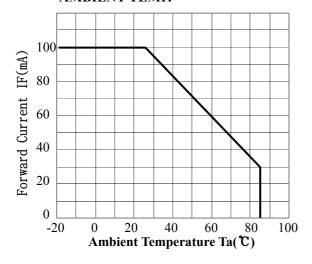
(Ta=25°C)

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward voltage	V_{F}	$I_F = 50 \text{mA}$		1.5	2.0	V
Reverse current	I_R	V _R =4V			10	μA
Capacitance	Ct	f=1 MHz		20		pF
Radiant intensity	Ie	$I_F = 50 \text{mA}$	50	120		mW/sr
Peak emission wavelength	λ_p	$I_F=50$ mA		880		nm
Spectral bandwidth 50%	Δλ	$I_F = 50 \text{mA}$		45		nm
Half angle	ΔΘ	$I_F = 50 \text{mA}$		±8		deg.
Optical rise & fall time(10%~90%)	tr/tf	$I_F = 50 \text{mA}$		25/15		ns
Cut off frequency *3	fc	I _F =50mA DC +10mA p-p		14		MHz

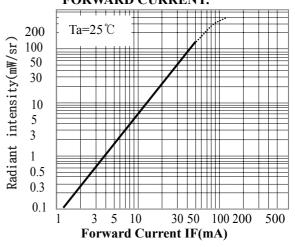
^{*3. 10}logPo(fc MHz)/Po(0.1 MHz)=-3

^{*2.} Lead Soldering Temperature (2mm from case for 5sec.).

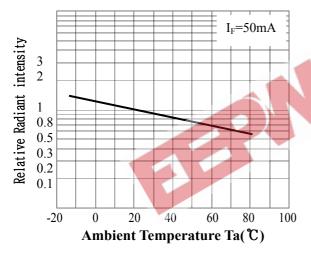
• FORWARD CURRENT Vs. AMBIENT TEMP.



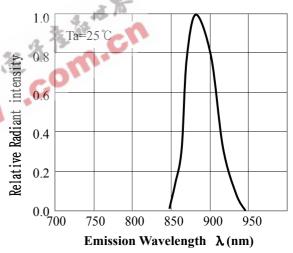
• RADIANT INTENSITY Vs. FORWARD CURRENT.



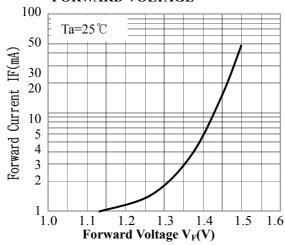
• RELATIVE RADIANT INTENSITY Vs. AMBIENT TEMP.



• RELATIVE RADIANT INTENSITY Vs. EMISSION WAVELENGTH.



• FORWARD CURRENT Vs. FORWARD VOLTAGE



• ANGULAR DISPLACEMENT Vs RELATIVE RADIANT INTENSITY

